BT013

1500-4000 MHz Medium Power Amplifier



Device Features

- OIP3 = 45.0 dBm @ 1900 MHz
- Gain = 15.0 dB @ 1900 MHz
- Output P1 dB = 27.5 dBm @ 1900 MHz
- 50 Ω Cascadable
- Patented Over Voltage Protection Circuit
- Lead-free/RoHS-compliant SOT-89 SMT package



Product Description

BeRex's BT013 is a high performance and a high dynamic range amplifier in a low cost surface mount package(SOT-89) with a RoHS -compliant, that incorporates reliable heterojunction-bipolar-transistor (HBT) devices fabricated with InGaP GaAs technology. This device is designed for use where high linearity is required and features high OIP3 and P1 with low consumption current (135mA) and requires a few external matching components such as a DC blocking capacitors on the In/Output pin, a bypass capacitor and a RF choke for the out port. All devices are 100% RF/DC tested.

- Base station Infrastructure/RFID
- Commercial/Industrial/Military wireless system

Applications

Application Circuits

Block

Typical Performance¹

Parameter		Frequ	iency		Unit
	1900	2140	2400	3500	MHz
Gain	15.0	14.0	13.2	10.7	dB
S11	-17.5	-12.0	-13.0	-26.0	dB
S22	-12.5	-12.0	-13.0	-25.0	dB
OIP3 ²	45.0	45.0	43.0	40.0	dBm
P1dB	27.5	27.2	27.0	26.0	dBm
IS-95C ACPR	21.0	-	-	-	dBm
WCDMA ACLR	-	19.5	18.5	-	dBm
Noise Figure	6.8	6.8	6.8	7.1	dB

Device performance $_$ measured on a BeRex evaluation board at 25°C, 50 Ω system.

^{*}ACPR&ACLR CH Power _ measured at 45dBc.

	Min.	Typical	Max.	Unit
Bandwidth	1500		4000	MHz
I _c @ (Vc = 5V)	115	135	155	mA
V _C		5.0		V
R _{TH}		50		°C/W

Absolute Maximum Ratings

Parameter	Rating	Unit
Operating Case Temperature	-40 to +85	°C
Storage Temperature	-55 to +155	°C
Junction Temperature	+220	°C
Operating Voltage	+7.0	V
Supply Current	200	mA
Input RF Power	23	dBm

^{*}Operation of this device above any of these parameters may result in permanent damage.

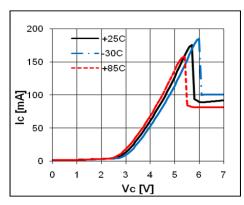
^{*}external matching circuit: refer to the page 6 to 12.

² OIP3 _ measured with two tones at an output of 13 dBm per tone separated by 1 MHz.

1500-4000 MHz Medium Power Amplifier

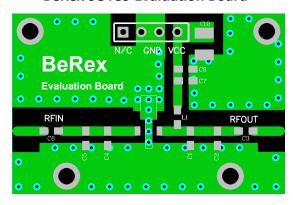


V-I Characteristics



^{*}Voltage protection works at 5~6 V

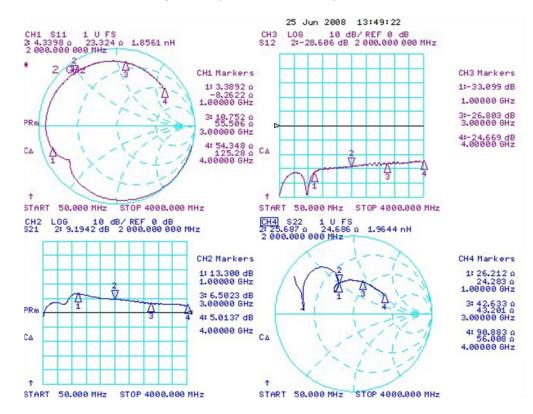
BeRex SOT89 Evaluation Board



*Dielectric constant _ 4.2 *RF pattern width 52mil *31mil thick FR4 PCB

Typical Device Data

S-parameters (Vc=5V, Ic=135mA, T=25°C)



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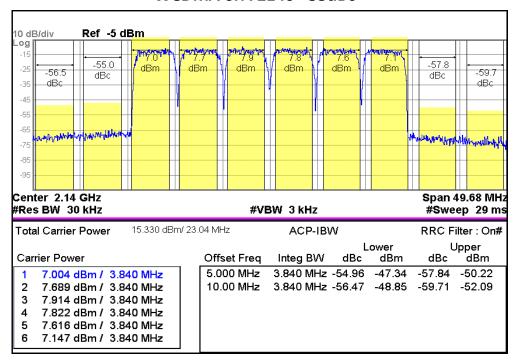
S-Parameter

(Vdevice = 5.0V, Icc = 135mA, T = 25 °C, calibrated to device leads)

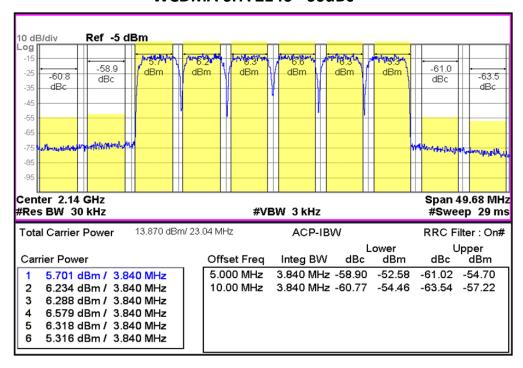
Freq	S11	S11	S21	S21	S12	S12	S22	S22
[MHz]	[Mag]	[Ang]	[Mag]	[Ang]	[Mag]	[Ang]	[Mag]	[Ang]
100	-0.046	-30.149	2.219	-128.4	-41.958	66.107	-3.497	165.97
500	-0.952	-116.77	6.737	-174.18	-32.703	25.318	-3.457	162.64
1000	-1.111	-162.01	13.26	161.56	-32.513	76.255	-7.557	117.5
1500	-0.928	157.99	10.718	121.35	-30.171	46.516	-7.780	127.17
2000	-1.240	129.31	9.181	101.55	-28.599	42.527	-7.262	116.25
2500	-1.390	104.6	8.334	81.201	-26.76	37.808	-7.180	97.537
3000	-1.669	82.694	6.491	66.725	-26.706	32.623	-7.38	74.648
3500	-1.989	60.455	6.124	51.795	-25.792	26.141	-7.336	50.666
4000	-2.281	37.752	5.024	33.795	-24.653	20.698	-6.823	32.131



WCDMA 6FA 2140 -55dBc



WCDMA 6FA 2140 -60dBc



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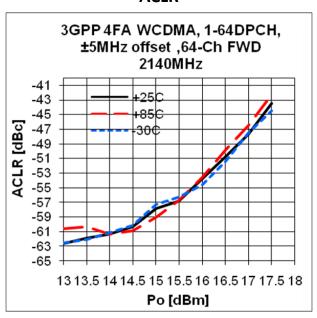
•website: www.berex.com

• email: sales@berex.com

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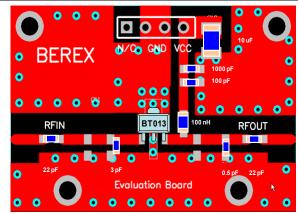
ACLR





Application Circuit: 1900 MHz

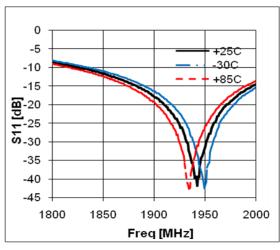
Schematic Diagram	В	ОМ	Tolerance
LEV	C1	100pF	±5%
C1 C2 C3 ^{+5V}	C2	1000pF	±5%
	C3	10uF	±20%
L1 &	C4	22pF	±5%
RFin C4 C5 RFout	C5	22pF	±5%
C6 T C7	C6	3pF	±5%
	C 7	0.5pF	±5%
* *	L1	100nH	±5%

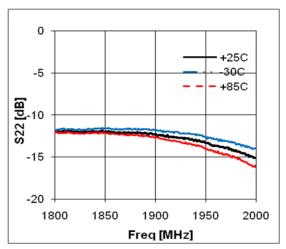


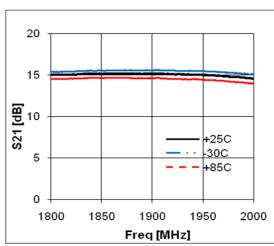
Note:

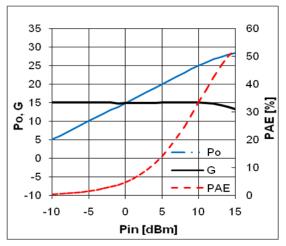
- 1. PCB: 31mil thick FR4.
- 2. Distance between the center of the shunt cap (C6) and the input pin of BT013 _ **3.2mm.**
- 3. Distance between the center of the shunt cap (C7) and the output pin of BT013 _ *8.3mm*.

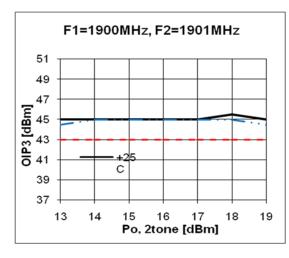


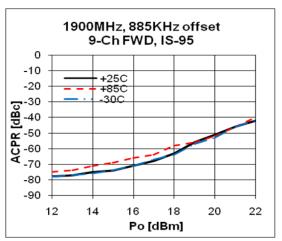








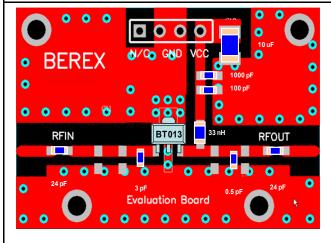






Application Circuit: 2140MHz

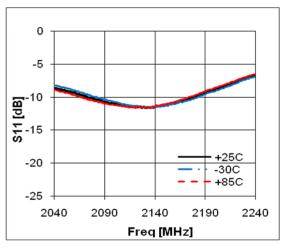
Schematic Diagram	E	ВОМ	Tolerance
C1 C2 C3 +5V	C1	100pF	±5%
	C2	1000pF	±5%
	C3	10uF	±20%
	C4	24pF	±5%
RFIN C4 C5 RFout	C5	24pF	±5%
C6 + C7	C6	3pF	±5%
	C7	0.5pF	±5%
-	L1	33nH	±5%

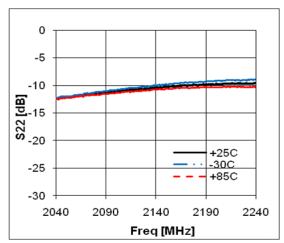


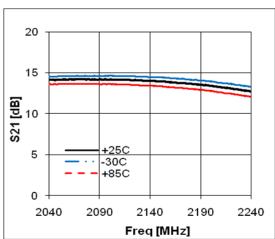
Note:

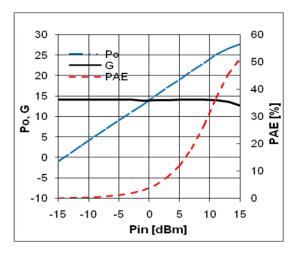
- 1. PCB: 31mil thick FR4
- 2. Distance between the center of the shunt cap (C6) and the input pin of BT013 _ **1.5mm.**
- 3. Distance between the center of the shunt cap (C7) and the output pin of BT013 _ *6.4mm*.

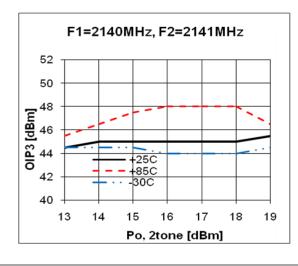


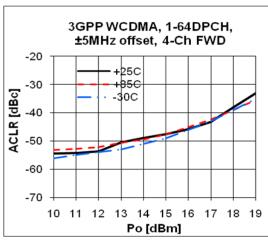








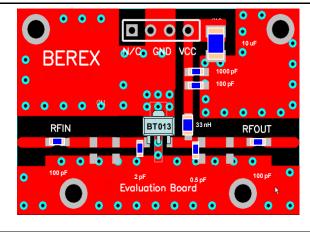






Application Circuit: 2400MHz

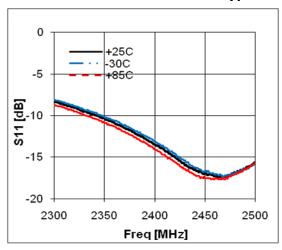
Schematic Diagram		вом	Tolerance
C1 C2 C3 ^{+5V}	C1	100pF	±5%
	C2	1000pF	±5%
	C3	10uF	±15%
	C4	100pF	±5%
RFin C4 C5 RFout	C 5	100pF	±5%
C6 T C7	C 6	2pF	±5%
·	C7	0.5pF	±5%
÷ - ÷	L1	33nH	±5%

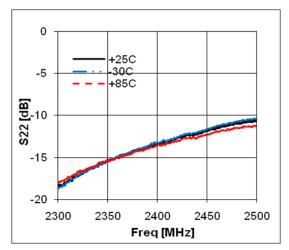


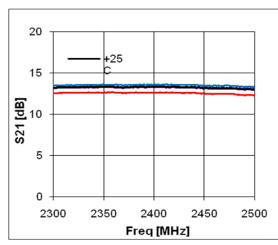
Note:

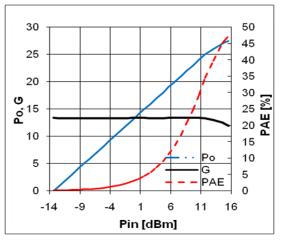
- 1. PCB: 31mil thick FR4
- Distance between the center of the shunt cap (C6) and the input pin of BT013 _ <u>0.7mm.</u>
- Distance between the center of the shunt cap (C7) and the output pin of BT013 _ <u>3.2mm.</u>

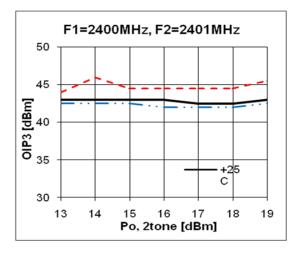


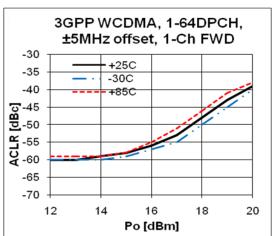












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•website: www.berex.com

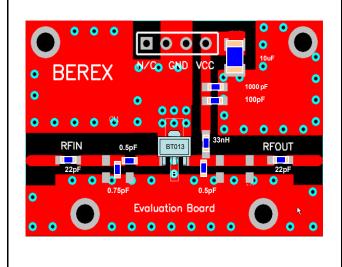
• email: sales@berex.com

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Application Circuit: 3500MHz

Schema	tic Diagram		вом	Tolerance
	C1 C2 C3 +5V	C1	100pF	±5%
	C1 C2 C3 13V	C2	1000pF	±5%
		C3	10uF	±20%
		C4	22pF	±5%
RFin C4 C7	÷ ÷ ÷ C5 RFout	C5	22pF	±5%
BT013		C 6	0.75pF	±5%
C6 T	C8	C 7	0.5pF	±5%
<u> </u>		C8	0.5pF	±5%
		L1	33nH	±5%

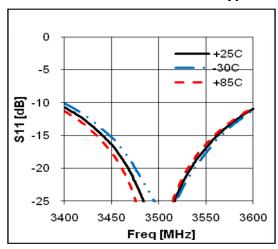


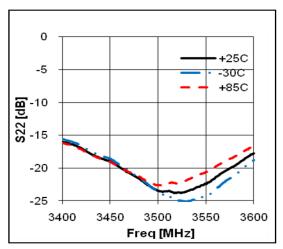
Note:

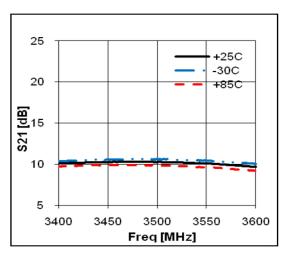
- 1. PCB: 31mil thick FR4
- Distance between the center of the shunt cap (C6) and the input pin of BT013 _ 10mm.
- Distance between the center of the series cap (C7) and the input pin of BT013 _ 4mm.
- 4. Distance between the center of the shunt cap (C8) and the output pin of BT013 _ <u>3mm.</u>

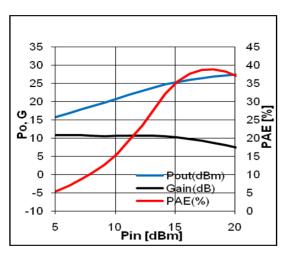
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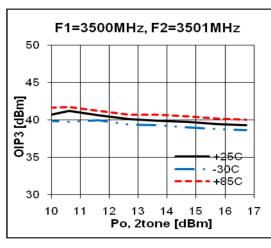








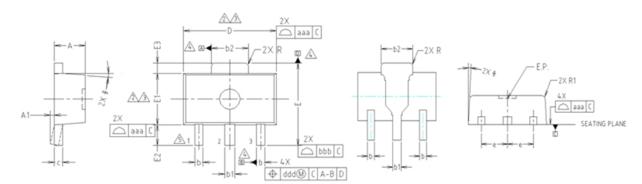




1500-4000 MHz Medium Power Amplifier



Package Outline Dimension



NOTE:

1. DIMENSIONS IN MILLIMETERS.

DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 8.5mm PER END.

DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION.

INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 8.5mm PER SIDE.

DIMENSIONS D AND E1 ARE DETERMINED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.

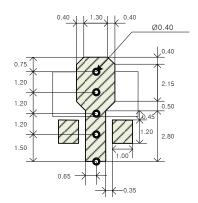
A DATUMS A, B AND D TO BE DETERMINED 8.18mm FROM THE LEAD TIP.

TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

		MILLI	METERS	S	NOTE
SYMBOL	MINIMUM	NON	JINAL	MAXIMUM	NOIE
A	1.40	1	.50	1.60	
A1	0.00		_	0.10	
Ь	0.38	0).42	0.48	
ь1	0.48	0).52	0.58	
b2	1.79	1	.82	1.87	
C	0.40	0	.42	0.46	
D	4.40	4	.50	4.70	2,3
E	3.70	4	.00	4.30	
E E1	2.40	2	.50	2.70	2,3
E2	0.80	1	.00	1.20	
E3	0.40	0	.50	0.60	
e		1.5	0 TYP.		
0			TYP.		
R		0.1	5 TYP.		
R1	-		_	0.20	
SYMBOL	TOLERANCES OF AND POSI	FORM	NOTE		
aaa	0.15				
bbb	0.20				
ccc	0.10				
ddd	0.10			1	

Suggested PCB Land Pattern and PAD Layout

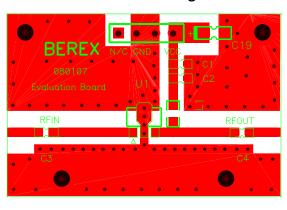
PCB Land Pattern



Note: All dimension are in millimeters

PCB lay out _ on BeRex website

PCB Mounting



BeRex

•website: www.berex.com

email: <u>sales@berex.com</u>

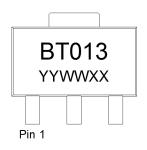
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BT013

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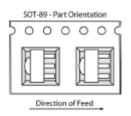
Package Marking



YY = Year, WW = Working Week, XX = Wafer No.

Tape & Reel





Packaging information:

Tape Width (mm): 12

Reel Size (inches): 7

Device Cavity Pitch (mm): 8

Devices Per Reel: 1000

Lead plating finish

100% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)

MSL / ESD Rating

ESD Rating: Class 1B

Value: Passes <1000V

Test: Human Body Model (HBM)

Standard: JEDEC Standard JESD22-A114B

MSL Rating: Level 1 at +265°C convection reflow

Standard: JEDEC Standard J-STD-020

NATO CAGE code:

2 N 9 6 F
